



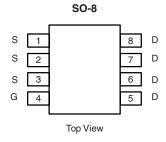
P-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	(V) R _{DS(on)} (Ω)			
- 30	0.042 at V _{GS} = - 10 V	- 5.7		
	0.055 at V _{GS} = - 6 V	- 5.0		
	0.070 at V _{GS} = - 4.5 V	- 4.4		

FEATURES

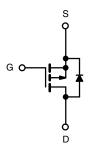
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET
- Compliant to RoHS Directive 2002/95/EC





Ordering Information: Si9435BDY-T1-E3 (Lead (Pb)-free)

Si9435BDY-T1-GE3 (Lead (Pb)-free and Halogen-free)



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T	_A = 25 °C, unle	ss otherwise n	oted		
Parameter		Symbol	10 s	Steady State	Unit
Drain-Source Voltage		V _{DS}	- 30		V
Gate-Source Voltage		V _{GS}	± 20		
Continuous Dunin Comment /T 450 90\8	T _A = 25 °C	I _D	- 5.7	- 4.1	
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 70 °C		- 4.6	- 3.2	
Pulsed Drain Current		I _{DM}	- 30		A
Continuous Source Current (Diode Conduction) ^a		I _S	- 2.3	- 1.1	I
	T _A = 25 °C	P _D	2.5	1.3	- W
Maximum Power Dissipation ^a	T _A = 70 °C		1.6	0.8	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Manifestory London to Applicated	t ≤ 10 s	R _{thJA}	40	50	°C/W	
Maximum Junction-to-Ambient ^a	Steady State		70	95		
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	24	30		

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

Si9435BDY

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Parameter	Symbol	Test Conditions	Min.	Typ. ^a	Max.	Unit	
Static							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 1.0		- 3.0	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 30 V, V _{GS} = 0 V	= 0 V		- 1		
		V _{DS} = - 30 V, V _{GS} = 0 V, T _J = 70 °C			- 5	μΑ	
On-State Drain Current ^b		$V_{DS} \le -10 \text{ V}, V_{GS} = -10 \text{ V}$	- 20			A	
	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	- 5				
Drain-Source On-State Resistance ^b		V _{GS} = - 10 V, I _D = - 5.7 A		0.033	0.042	Ω	
	R _{DS(on)}	V _{GS} = - 6 V, I _D = - 5 A		0.043	0.055		
		V _{GS} = - 4.5 V, I _D = - 4.4 A		0.056	0.070		
Forward Transconductance ^b	9 _{fs}	V _{DS} = - 15 V, I _D = - 5.7 A		13		S	
Diode Forward Voltage ^b	V_{SD}	I _S = - 2.3 A, V _{GS} = 0 V		- 0.8	- 1.1	V	
Dynamic ^a							
Total Gate Charge	Q_g			16	24		
Gate-Source Charge	Q_{gs}	Q_{gs} $V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -3.5 \text{ A}$		2.3		nC	
Gate-Drain Charge	Q_{gd}			4.5			
Gate Resistance	R_{g}			8.8		Ω	
Turn-On Delay Time	t _{d(on)}			14	25		
Rise Time	t _r	V_{DD} = - 15 V, R_L = 15 Ω		14	25	1	
Turn-Off Delay Time	t _{d(off)}	$I_{D} \cong -1 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 6 \Omega$		42	70	ns	
Fall Time	t _f			30	50		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = - 1.2 A, dI/dt = 100 A/μs		30	60		

Notes:

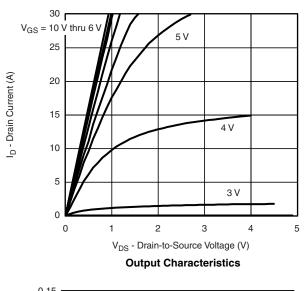
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

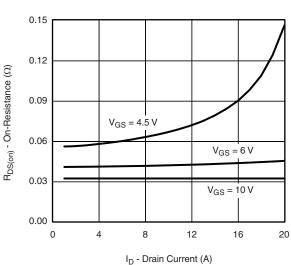
a. Guaranteed by design, not subject to production testing.

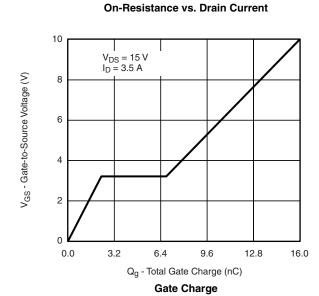
b. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$

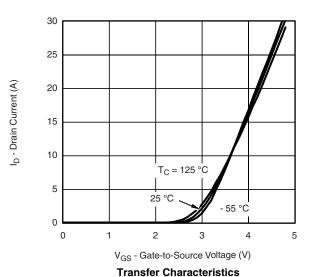


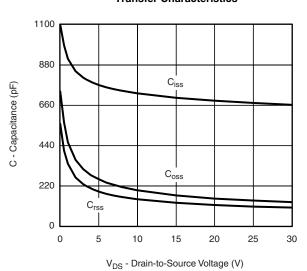
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



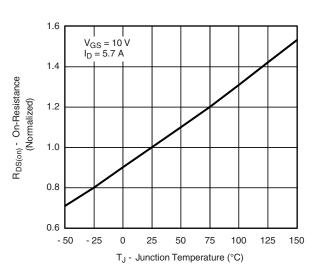








Capacitance

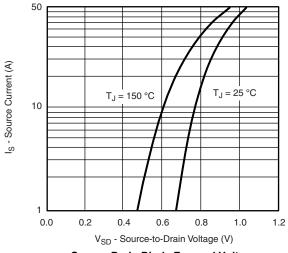


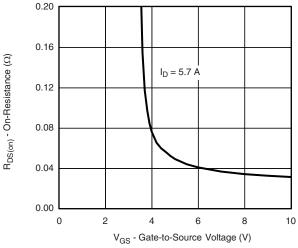
On-Resistance vs. Junction Temperature

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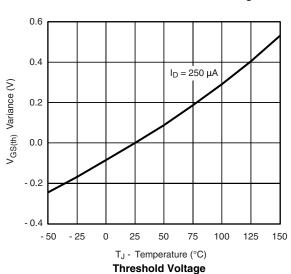
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

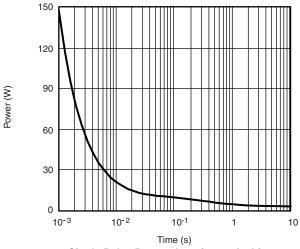




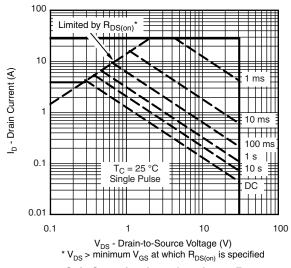
Source-Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage



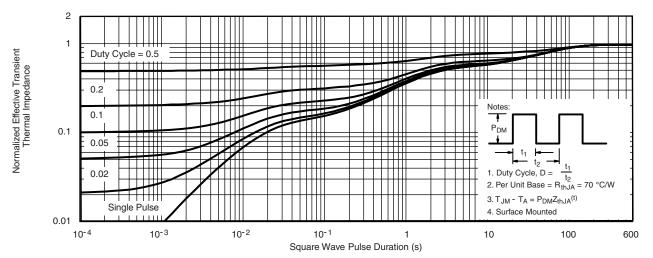
Single Pulse Power, Junction-to-Ambient



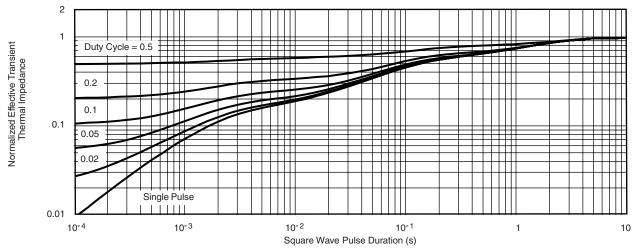
Safe Operating Area, Junction-to-Foot



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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